



**THE DATASHEET OF  
ZXMS6005DT8TA**



## Product Summary

|   |       |
|---|-------|
| • Continuous Drain Source Voltage             | 60V   |
| • On-State Resistance                         | 200mΩ |
| • Nominal Load Current (V <sub>IN</sub> = 5V) | 1.8A  |
| • Clamping Energy                             | 210mJ |

## Description

The ZXMS6005DT8 is a dual self protected low side MOSFET with logic level input. It integrates over-temperature, over-current, over-voltage (active clamp) and ESD protected logic level functionality. The ZXMS6005DT8 is ideal as a general purpose switch driven from 3.3V or 5V microcontrollers in harsh environments where standard MOSFETs are not rugged enough.

## Applications

- Lamp Driver
- Motor Driver
- Relay Driver
- Solenoid Driver

## Features and Benefits

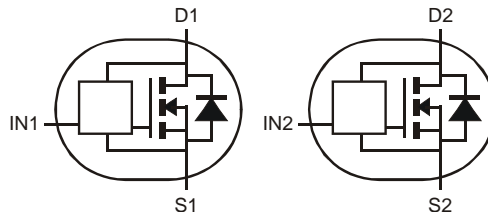
- Compact Dual Package
- Low Input Current
- Logic Level Input (3.3V and 5V)
- Short Circuit Protection with Auto Restart
- Over Voltage Protection (active clamp)
- Thermal Shutdown with Auto Restart
- Over-Current Protection
- Input Protection (ESD)
- High Continuous Current Rating
- **Lead-Free Finish; RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **AEC-Q101-006 Short Circuit Reliability Characterized**
- **PPAP Capable (Note 4)**

## Mechanical Data

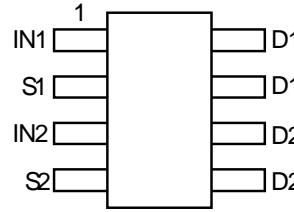
- Case: SM-8
- Case Material: Molded Plastic, "Green" Molding Compound  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish (e3)
- Weight: 0.117 grams (approximate)



Top View



Device Symbol



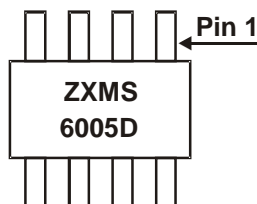
Top View  
Pin-Out

## Ordering Information (Note 4)

| Product       | Marking   | Reel size (inches) | Tape width (mm) | Quantity per reel |
|---------------|-----------|--------------------|-----------------|-------------------|
| ZXMS6005DT8TA | ZXMS6005D | 7                  | 12              | 1,000             |

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to [http://www.diodes.com/quality/product\\_compliance\\_definitions/](http://www.diodes.com/quality/product_compliance_definitions/).
  5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

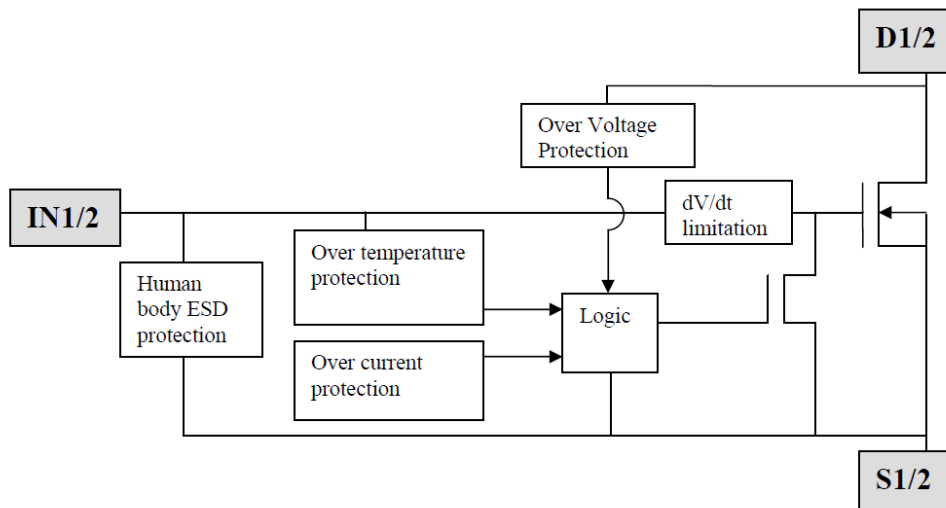
## Marking Information



ZXMS6005D = Product Type Marking Code

Top View

## Functional Block Diagram



## Application Information

- Two completely isolated independent channels
- Especially suited for loads with a high in-rush current such as lamps and motors
- All types of resistive, inductive and capacitive loads in switching applications
- $\mu\text{C}$  compatible power switch for 12V DC applications
- Automotive rated
- Replaces electromechanical relays and discrete circuits
- Linear Mode Capability - the current-limiting protection circuitry is designed to de-activate at low  $V_{\text{DS}}$  to minimise on state power dissipation. The maximum DC operating current is therefore determined by the thermal capability of the package/board combination, rather than by the protection circuitry. This does not compromise the product's ability to self-protect at low  $V_{\text{DS}}$

## Maximum Ratings (@ $T_{\text{A}} = +25^{\circ}\text{C}$ , unless otherwise specified.)

| Characteristic   | Symbol              | Value                    | Units |
|--|---------------------|--------------------------|-------|
| Continuous Drain-Source Voltage  | $V_{\text{DS}}$     | 60                       | V     |
| Drain-Source Voltage For Short Circuit Protection  | $V_{\text{DS(SC)}}$ | 24                       | V     |
| Continuous Input Voltage   | $V_{\text{IN}}$     | -0.5 to +6               | V     |
| Continuous Input Current @ $-0.2\text{V} \leq V_{\text{IN}} \leq 6\text{V}$  | $I_{\text{IN}}$     | No limit                 | mA    |
| Continuous Input Current @ $V_{\text{IN}} < -0.2\text{V}$ or $V_{\text{IN}} > 6\text{V}$   | $I_{\text{IN}}$     | $ I_{\text{IN}}  \leq 2$ | mA    |
| Pulsed Drain Current @ $V_{\text{IN}} = 3.3\text{V}$ ( Note 7)   | $I_{\text{DM}}$     | 5                        | A     |
| Pulsed Drain Current @ $V_{\text{IN}} = 5\text{V}$ ( Note 7)   | $I_{\text{DM}}$     | 6                        | A     |
| Continuous Source Current (Body Diode) (Note 5)  | $I_{\text{S}}$      | 2.5                      | A     |
| Pulsed Source Current (Body Diode)   | $I_{\text{SM}}$     | 10                       | A     |
| Unclamped Single Pulse Inductive Energy,<br>$T_{\text{J}} = +25^{\circ}\text{C}$ , $I_{\text{D}} = 0.5\text{A}$ , $V_{\text{DD}} = 24\text{V}$ | $E_{\text{AS}}$     | 210                      | mJ    |
| Electrostatic Discharge (Human Body Model)   | $V_{\text{ESD}}$    | 4000                     | V     |
| Charged Device Model   | $V_{\text{CDM}}$    | 1000                     | V     |

**Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic  | Symbol           | Value        | Units      |
|---|------------------|--------------|------------|
| Power Dissipation at T <sub>A</sub> = +25°C (Notes 5 & 8)<br>Linear Derating Factor | P <sub>D</sub>   | 1.16<br>9.28 | W<br>mW/°C |
| Power Dissipation at T <sub>A</sub> = +25°C (Notes 5 & 9)<br>Linear Derating Factor | P <sub>D</sub>   | 1.67<br>13.3 | W<br>mW/°C |
| Power Dissipation at T <sub>A</sub> = +25°C (Notes 6 & 8)<br>Linear Derating Factor | P <sub>D</sub>   | 2.13<br>17   | W<br>mW/°C |
| Thermal Resistance, Junction to Ambient (Notes 5 & 8)                               | R <sub>θJA</sub> | 108          | °C/W       |
| Thermal Resistance, Junction to Ambient (Notes 5 & 9)                               | R <sub>θJA</sub> | 75           | °C/W       |
| Thermal Resistance, Junction to Case (Notes 6 & 8)                                  | R <sub>θJC</sub> | 58.7         | °C/W       |
| Thermal Resistance, Junction to Case (Note 10)                                      | R <sub>θJC</sub> | 26.5         | °C/W       |
| Operating Temperature Range   | T <sub>J</sub>   | -40 to +150  | °C         |
| Storage Temperature Range   | T <sub>STG</sub> | -55 to +150  | °C         |

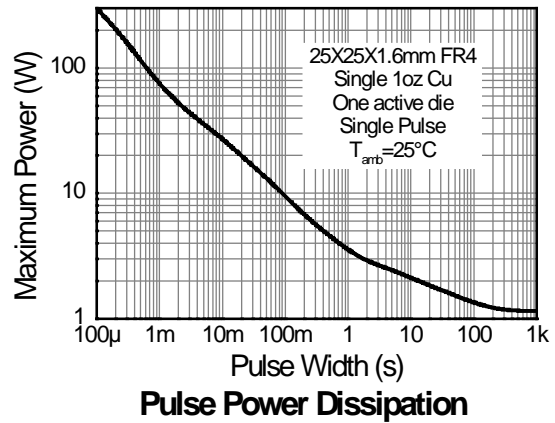
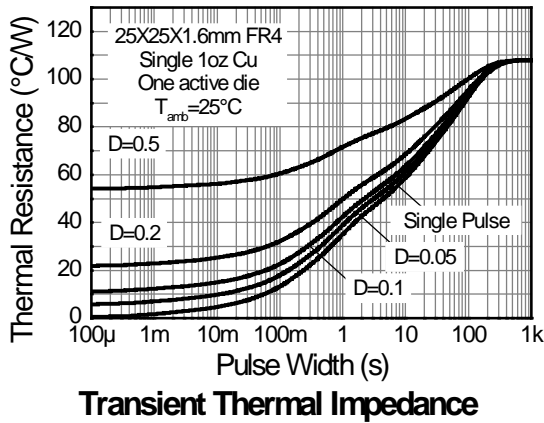
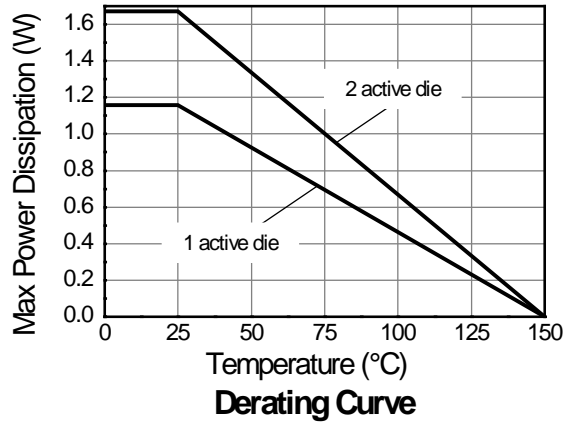
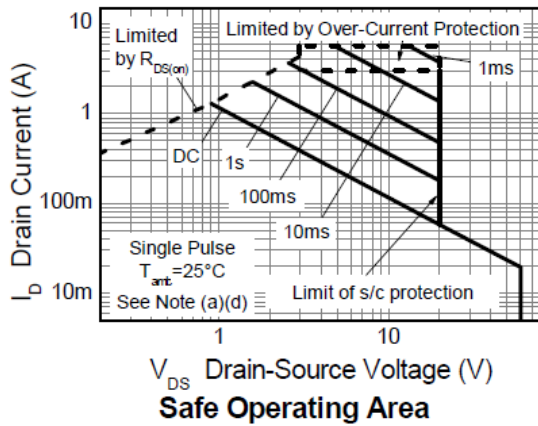
- Notes:
- For a dual device surface mounted on a 25mm x 25mm single sided 1oz weight copper split down the middle on 1.6mm FR4 board, in still air conditions.
  - For a dual device surface mounted on FR4 PCB measured at t ≤ 10sec.
  - Repetitive rating 25mm x 25mm FR4 PCB, D = 0.02, Pulse width = 300µs – pulse width limited by junction temperature. Refer to transient thermal impedance graph.
  - For a dual device with one active die.
  - For a dual device with 2 active die running at equal power.
  - Thermal resistance from junction to the mounting surface of the drain pin.

**Recommended Operating Conditions**

The ZXMS6005DT8 is optimized for use with µC operating from 3.3V and 5V supplies.

| Characteristic  | Symbol          | Min | Max  | Unit |
|---|-----------------|-----|------|------|
| Input Voltage Range   | V <sub>IN</sub> | 0   | 5.5  | V    |
| Ambient Temperature Range                                     | T <sub>A</sub>  | -40 | +125 | °C   |
| High Level Input Voltage for MOSFET to be on                  | V <sub>IH</sub> | 3   | 5.5  | V    |
| Low Level Input Voltage for MOSFET to be off                  | V <sub>IL</sub> | 0   | 0.7  | V    |
| Peripheral Supply Voltage (voltage to which load is referred) | V <sub>P</sub>  | 0   | 24   | V    |

**Thermal Characteristics**

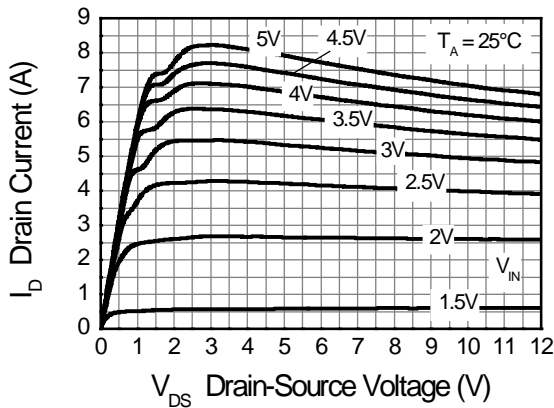


**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

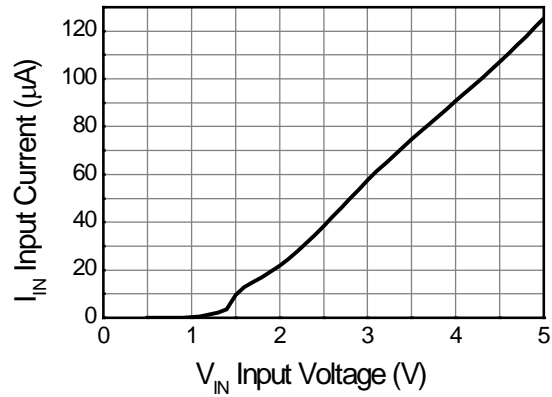
| Characteristic                              | Symbol              | Min | Typ | Max | Unit | Test Condition   |
|---|---------------------|-----|-----|-----|------|--|
| <b>Static Characteristics</b>               |                     |     |     |     |      |  |
| Drain-Source Clamp Voltage                  | V <sub>DS(AZ)</sub> | 60  | 65  | 70  | V    | I <sub>D</sub> = 10mA  |
| Off State Drain Current                     | I <sub>DSS</sub>    | —   | —   | 1   | μA   | V <sub>DS</sub> = 12V, V <sub>IN</sub> = 0V                      |
|   |                     | —   | —   | 2   |      | V <sub>DS</sub> = 36V, V <sub>IN</sub> = 0V                      |
| Input Threshold Voltage                     | V <sub>IN(th)</sub> | 0.7 | 1   | 1.5 | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1mA         |
| Input Current                               | I <sub>IN</sub>     | —   | 60  | 100 | μA   | V <sub>IN</sub> = +3V  |
|   |                     | —   | 120 | 200 |      | V <sub>IN</sub> = +5V  |
| Input Current while Over Temperature Active | —                   | —   | —   | 300 | μA   | V <sub>IN</sub> = +5V  |
| Static Drain-Source On-State Resistance     | R <sub>DS(on)</sub> | —   | 170 | 250 | mΩ   | V <sub>IN</sub> = +3V, I <sub>D</sub> = 1A                       |
|   |                     | —   | 150 | 200 |      | V <sub>IN</sub> = +5V, I <sub>D</sub> = 1A                       |
| Continuous Drain Current (Notes 5 & 9)      | I <sub>D</sub>      | 1.4 | —   | —   | A    | V <sub>IN</sub> = 3V; T <sub>A</sub> = +25°C                     |
|   |                     | 1.6 | —   | —   |      | V <sub>IN</sub> = 5V; T <sub>A</sub> = +25°C                     |
| Continuous Drain Current (Notes 5 & 8)      |                     | 1.7 | —   | —   |      | V <sub>IN</sub> = 3V; T <sub>A</sub> = +25°C                     |
|   |                     | 1.8 | —   | —   |      | V <sub>IN</sub> = 5V; T <sub>A</sub> = +25°C                     |
| Current Limit (Note 11)                     | I <sub>D(LIM)</sub> | 2.2 | 5   | —   | A    | V <sub>IN</sub> = +3V  |
|   |                     | 3.3 | 7   | —   |      | V <sub>IN</sub> = +5V  |
| <b>Dynamic Characteristics</b>              |                     |     |     |     |      |  |
| Turn On Delay Time                          | t <sub>d(on)</sub>  | —   | 6   | —   | μs   | V <sub>DD</sub> = 12V, I <sub>D</sub> = 1A, V <sub>GS</sub> = 5V |
| Rise Time                                   | t <sub>r</sub>      | —   | 14  | —   | μs   |  |
| Turn Off Delay Time                         | t <sub>d(off)</sub> | —   | 34  | —   | μs   |  |
| Fall Time                                   | t <sub>f</sub>      | —   | 19  | —   | μs   |  |
| <b>Over-Temperature Protection</b>          |                     |     |     |     |      |  |
| Thermal Overload Trip Temperature (Note 12) | T <sub>JT</sub>     | 150 | 175 | —   | °C   | —  |
| Thermal Hysteresis (Note 12)                | f <sub>f</sub>      | —   | 10  | —   | °C   | —  |

- Notes:
- The drain current is restricted only when the device is in saturation (see graph 'typical output characteristic'). This allows the device to be used in the fully on state without interference from the current limit. The device is fully protected at all drain currents, as the low power dissipation generated outside saturation makes current limit unnecessary.
  - Over-temperature protection is designed to prevent device destruction under fault conditions. Fault conditions are considered as "outside" normal operating range, so this part is not designed to withstand over-temperature for extended periods.

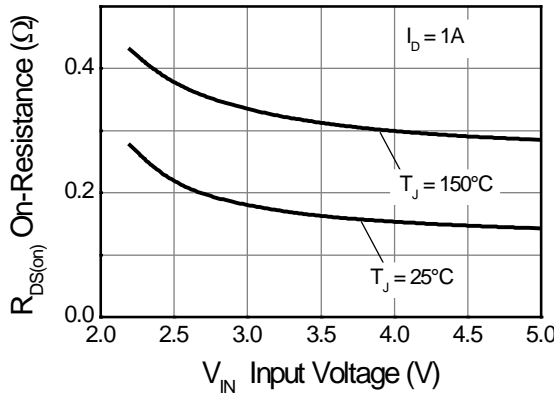
**Typical Characteristics**



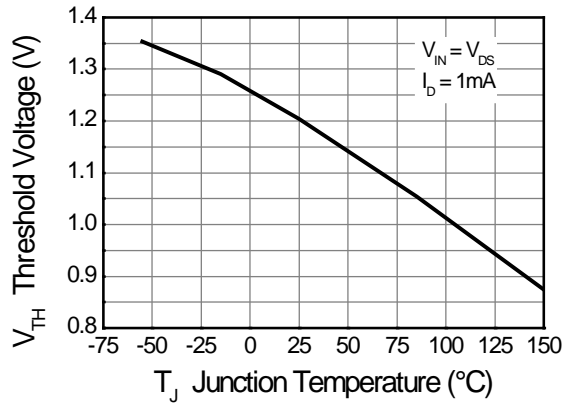
**Typical Output Characteristic**



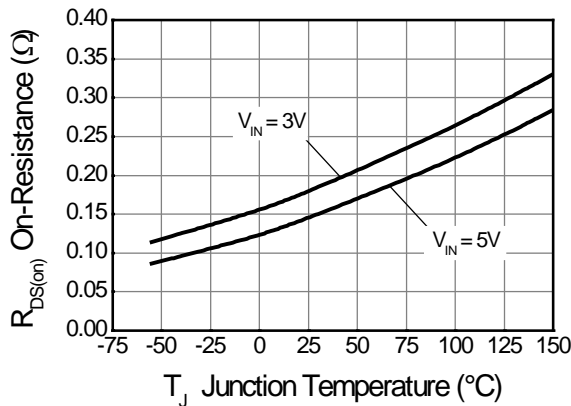
**Input Current vs Input Voltage**



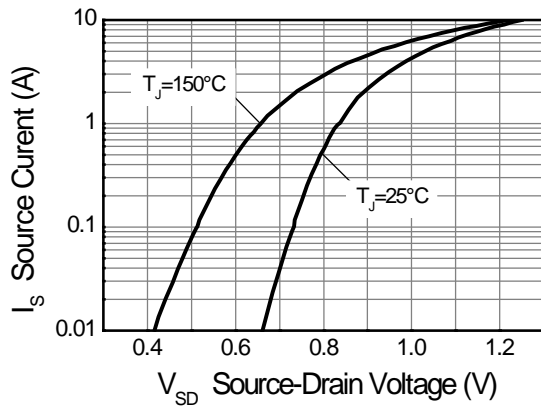
**On-Resistance vs Input Voltage**



**Threshold Voltage vs Temperature**

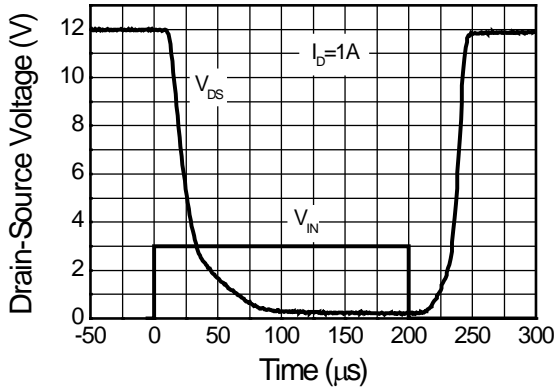


**On-Resistance vs Temperature**

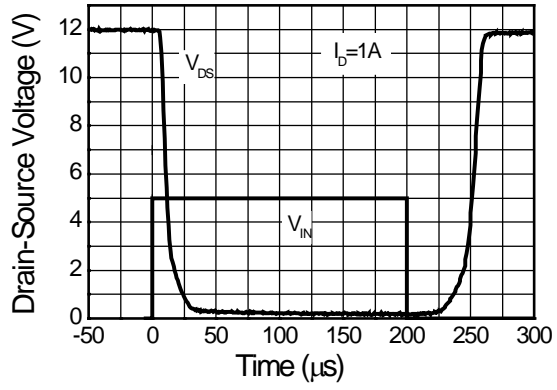


**Reverse Diode Characteristic**

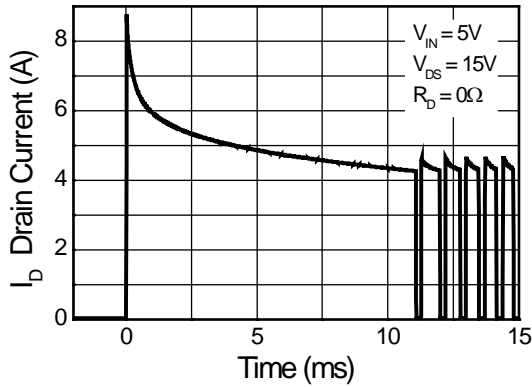
**Typical Characteristics** (cont.)



**Switching Speed**



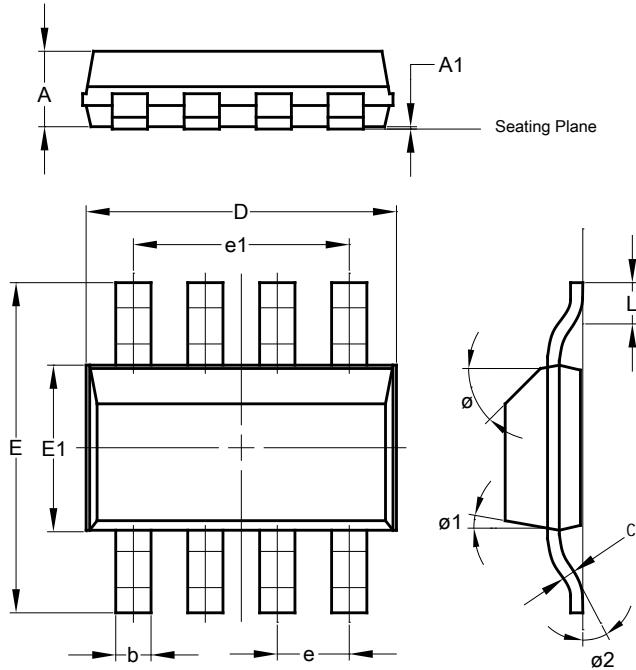
**Switching Speed**



**Typical Short Circuit Protection**

## Package Outline Dimensions

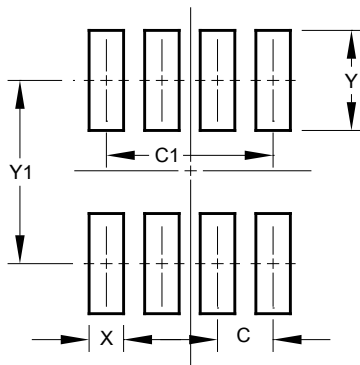
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



| SM-8                 |          |      |      |
|----------------------|----------|------|------|
| Dim                  | Min      | Max  | Typ  |
| A                    | --       | 1.70 | 1.60 |
| A1                   | 0.02     | 0.10 | 0.04 |
| b                    | 0.70     | 0.90 | 0.80 |
| c                    | 0.24     | 0.32 | 0.28 |
| D                    | 6.30     | 6.70 | 6.60 |
| e                    | 1.53 REF |      |      |
| e1                   | 4.59 REF |      |      |
| E                    | 6.70     | 7.30 | 7.00 |
| E1                   | 3.30     | 3.70 | 3.50 |
| L                    | 0.75     | 1.00 | 0.90 |
| ø                    | --       | --   | 45°  |
| ø1                   | --       | 15°  | --   |
| ø2                   | --       | --   | 10°  |
| All Dimensions in mm |          |      |      |

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 1.52          |
| C1         | 4.60          |
| X          | 0.95          |
| Y          | 2.80          |
| Y1         | 6.80          |

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